

Committee Details (ENVELOPE –II)

Tender ID: 2026_AAI_277705_1

Name of Work: Repair of damaged pavement joints with Polysulphide sealing compound after removal of damaged sealants, repair of joint cracks and small potholes on Runway, Taxiway, Apron and allied locations at Tezu Airport.

Sl. No.	Name	Designation	Response
1.	Sh. Arup Hatibaruah	AGM(E-C)	Committee Chairperson, Bid Manager, Bid Evaluator.
2	Sh. Chittaranjan Das	Mgr(E-C)	Bid Evaluator
3	Sh. Ajit Dutta	AGM(Fin)	Bid Opener

01 no. of bidder have been accepted out of 04 nos. of bidder as L1 (Lowest bidder) in Envelope-II (Financial evaluation).

Signature Not Verified

Digitally signed by ARUP HATIBARUAH
Date: 2026.08.04 15:52:14 IST
Location: eProcurement System for
Central PSUs